



IPW

Attorney's Docket No.: 42P13856D

Patent

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:)
Rahul N. Manepalli et al.) Examiner: Unassigned
Serial No.: 10/774,155) Art Unit: Unassigned
Filed: February 5, 2004)
For: AN UNDERFILLING PROCESS IN A)
MOLDED MATRIX ARRAY PACKAGE USING)
FLOW FRONT MODIFYING SOLDER RESIST)

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

SUPPLEMENTAL PRELIMINARY AMENDMENT

Sir:

Applicants respectfully request that this Preliminary Amendment be entered prior to examination of the above-identified patent application.

FIRST CLASS CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage in an envelope addressed to MAIL STOP _____
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U.S. Patent and Trademark Office, Washington, D.C. 20231 on May 25, 2004.

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Teresa Mattox
Signature

May 25, 2004
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